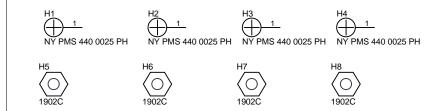


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## PCBA?

PCB Assembly

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PMP9380 Rev1B PCB

LBL1 PCB Label Size: 0.65" x 0.20 "

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Variant/Label Table				
Variant	Label Text			
001				

		Orderable:	ChangeMe!
		TID #:	PMP20999
		Number: Pl	MP20999
	Texas Instruments and/or its licensors do not warrant the accuracy or completeness of this specification or any information contained therein. Texas Instruments and/or its licensors do not	SVN Rev:	Version con
1	warrant that this design will meet the specifications, will be suitable for your application or fit for any particular purpose, or will operate in an implementation. Texas Instruments and/or its	Drawn By:	
1	icensors do not warrant that the design is production worthy. You should completely validate and test your design implementation to confirm the system functionality for your application.	Engineer: H	Irag Kaspari

le!		Designed for:	Mod. D	ate: 6/19/2017	
99		Project Title: LM46002 Inv	TEXAS		
	Rev: A	Sheet Title: Hardware			
ontrol disabled		Assembly Variant: 001		Sheet: 2 of 2	INSTREMENTS
		File: PMP20999_EVM_Ha	rdware.SchDoc	Size: B	http://www.ti.com
arian		Contact: http://www.ti.com/support			© Texas Instruments 2017
5				6	

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